

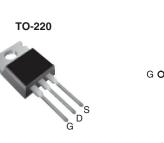
**Vishay Siliconix** 

RoHS

COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	200				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.80			
Q <sub>g</sub> (Max.) (nC)	14				
Q <sub>gs</sub> (nC)	3.0				
Q <sub>gd</sub> (nC)	7.9				
Configuration	Single				



S N-Channel MOSFET

### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead (Pb)-free Available

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRF620PbF
	SiHF620-E3
SnPb	IRF620
	SiHF620

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25 ^{\circ}C$ , unless otherwise noted							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V <sub>DS</sub>	200	V			
Gate-Source Voltage			V <sub>GS</sub>	± 20	V		
Continuous Drain Current	V	$T_{C} = 25 °C$ $T_{C} = 100 °C$	- I <sub>D</sub>	5.2			
	V <sub>GS</sub> at 10 V	$T_C = 100 ^{\circ}C$		3.3	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	18			
Linear Derating Factor			0.40	W/°C			
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	110	mJ		
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	5.2	A		
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	5.0	mJ		
Maximum Power Dissipation	n Power Dissipation $T_{C} = 25 \ ^{\circ}C$			P <sub>D</sub> 50			
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150				
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	- °C		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in		
				1.1	N · m		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 6.1 mH, R<sub>G</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5.2 A (see fig. 12).

c.  $I_{SD} \le 5.2$  A,  $dI/dt \le 95$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RA	TINGS								
PARAMETER	SYMBOL	TYP	-	MAX.		UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 -							
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>					°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	- 2.5						
		1							
<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$ ,	unless otherv	vise noted							
PARAMETER	SYMBOL	1		ONS	MIN.	TYP.	MAX.	UNIT	
Static	I				I	1		1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 μA	200	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$		e to 25 °C,	•	-	0.29	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>		= V <sub>GS</sub> , I <sub>D</sub> = 2		2.0	-	4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V	/	-	-	± 100	nA	
Zara Gata Valtaga Drain Current	I_	V <sub>DS</sub> =	200 V, V <sub>GS</sub>	= 0 V	-	-	25		
Zero Gate Voltage Drain Current	$V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		T <sub>J</sub> = 125 °C	-	-	250	μA		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> :	= 3.1 A <sup>b</sup>	-	-	0.80	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	= 50 V, I <sub>D</sub> =	3.1 A	1.5	-	-	S	
Dynamic									
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	260	-		
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 V,$		-	100	-	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	30	-	1		
Total Gate Charge	Qg				-	-	14		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		A, $V_{DS} = 160 V$ ,	-	-	3.0	nC	
Gate-Drain Charge	Q <sub>gd</sub>		see ng	. 6 and 13 <sup>b</sup>	-	-	7.9		
Turn-On Delay Time	t <sub>d(on)</sub>				-	7.2	-		
Rise Time	t <sub>r</sub>	- -	100 \/   _	4 Q A	_	22	-	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 100 V, $I_D$ = 4.8 A, $R_G$ = 18 $\Omega$ , $R_D$ = 20 $\Omega$ , see fig. 10 <sup>b</sup>		_	19	<u> </u>	ns		
Fall Time	t <sub>f</sub>			_	13				
	Ч					10			
Internal Drain Inductance	L <sub>D</sub>	Between lead 6 mm (0.25")			-	4.5	-	nH	
		package and							
Internal Source Inductance	Ls	die contact		-	7.5	-			
Drain-Source Body Diode Characteristic	cs					1	1	1	
Continuous Source-Drain Diode Current	Is	MOSFET sym	bol		_	_	5.2		
		showing the				0.2	A		
Pulsed Diode Forward Currenta	I <sub>SM</sub>	p - n junction diode			-	-		18	
Body Diode Voltage	V <sub>SD</sub>	$T_{J} = 25 \ ^{\circ}C, \ I_{S} = 5.2 \ A, \ V_{GS} = 0 \ V^{b}$			-	-	1.8	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 4.8 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}$		-	150	300	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.91	1.8	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn			-on is don	ninated b	l and l	· ·	

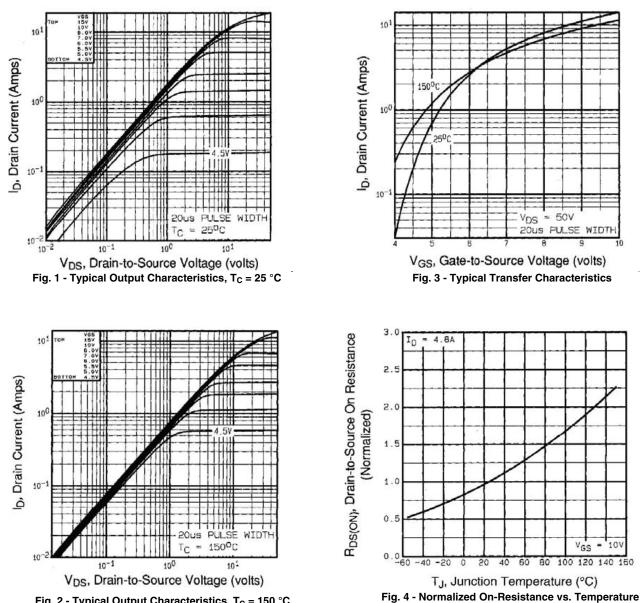
#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.



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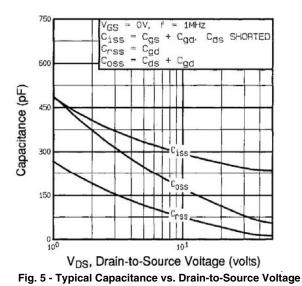


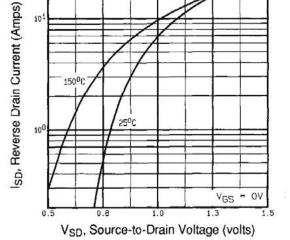
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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Fig. 7 - Typical Source-Drain Diode Forward Voltage

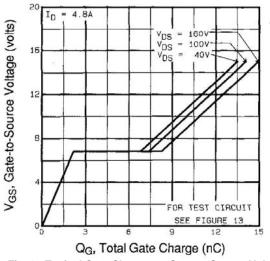
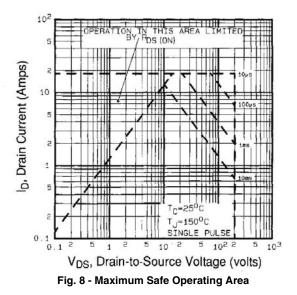
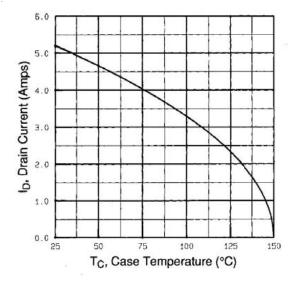


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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#### Fig. 9 - Maximum Drain Current vs. Case Temperature

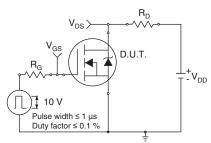


Fig. 10a - Switching Time Test Circuit

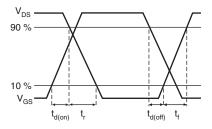
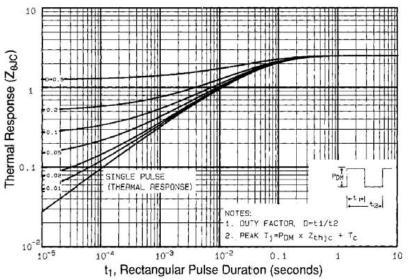


Fig. 10b - Switching Time Waveforms





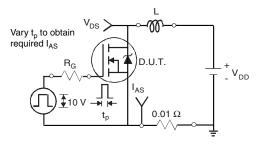


Fig. 12a - Unclamped Inductive Test Circuit

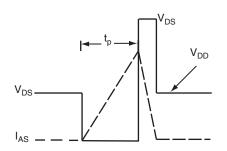


Fig. 12b - Unclamped Inductive Waveforms

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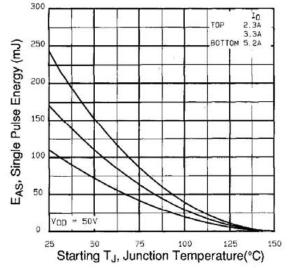


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

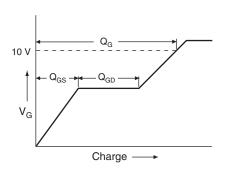
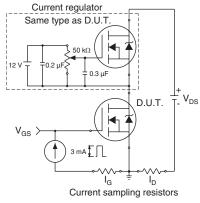
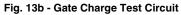


Fig. 13a - Basic Gate Charge Waveform

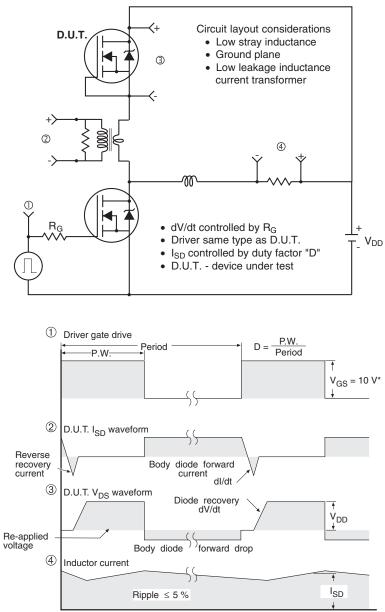






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Peak Diode Recovery dV/dt Test Circuit

\*  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

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